CS5205A-1

5.0 A Adjustable Linear Regulator

The CS5205A−1 linear regulator provides 5.0 A at an adjustable voltage with an accuracy of ±1%. Two external resistors are used to set the output voltage within a 1.25 V to 13 V range.

The regulator is intended for use as a post regulator and microprocessor supply. The fast loop response and low dropout voltage make this regulator ideal for applications where low voltage operation and good transient response are important.

The circuit is designed to operate with dropout voltages as low as 1.0 V depending on the output current level. The maximum quiescent current is only 10 mA at full load.

The regulator is fully protected against overload conditions with protection circuitry for Safe Operating Area (SOA), overcurrent and thermal shutdown.

The CS5205A−1 is pin compatible with the LT1084 family of linear regulators but has lower dropout voltage.

The regulator is available in TO−220−3 and surface mount D^2PAK−3 packages.

Features

- Output Current to 5.0 A
- Output Trimmed to ±1%
- Dropout Voltage 1.15 V @ 5.0 A
- Fast Transient Response
- Fault Protection Circuitry
  - Thermal Shutdown
  - Overcurrent Protection
  - Safe Area Protection

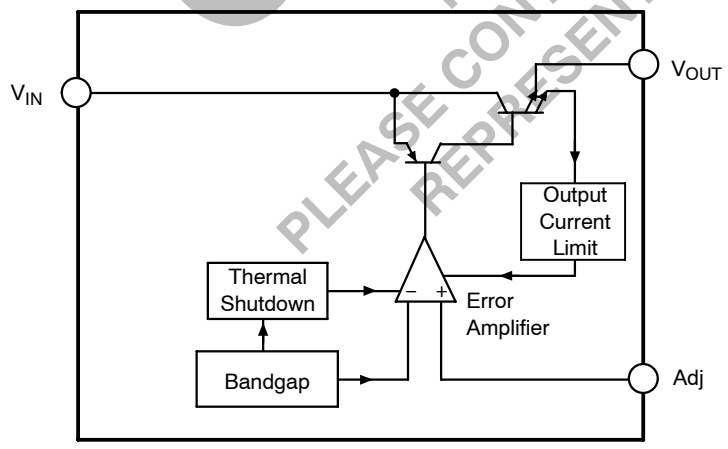
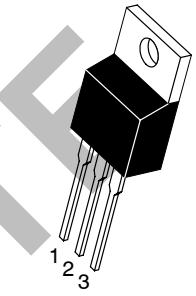


Figure 1. Block Diagram

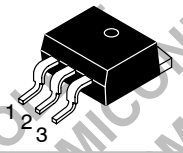
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TO−220−3
T SUFFIX
CASE 221A

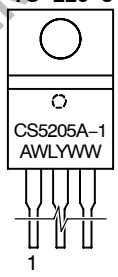


D^2PAK−3
DP SUFFIX
CASE 418AB

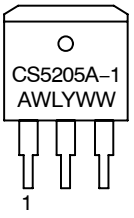
Tab = V_{OUT}
Pin 1. Adj
2. V_{OUT}
3. V_{IN}

MARKING DIAGRAMS

TO−220−3



D^2PAK−3



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

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MAXIMUM RATINGS*

Parameter		Value	Unit
Supply Voltage, V_{CC}		17	V
Operating Temperature Range		−40 to +70	°C
Junction Temperature		150	°C
Storage Temperature Range		−60 to +150	°C
Lead Temperature Soldering:	Wave Solder (through hole styles only) Note 1 Reflow (SMD styles only) Note 2	260 Peak 230 Peak	°C

1. 10 second maximum.
2. 60 second maximum above 183°C.

*The maximum package power dissipation must be observed.

ELECTRICAL CHARACTERISTICS (C_{IN} = 10 μF, C_{OUT} = 22 μF Tantalum, $V_{IN} - V_{OUT}$ = 3.0 V, $V_{IN} \le$ 15 V, 0°C ≤ $T_A \le$ 70°C, $T_J \le$ +150°C, unless otherwise specified, $I_{full\ load}$ = 5.0 A.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
Adjustable Output Voltage					
Reference Voltage (Notes 3 and 4)	$V_{IN} - V_{OUT}$ = 1.5 V; V_{Adj} = 0 V, 10 mA ≤ $I_{OUT} \le$ 5.0 A	1.241 (−1%)	1.254	1.266 (+1%)	V
Line Regulation	1.5 V ≤ $V_{IN} - V_{OUT} \le$ 6.0 V; I_{OUT} = 10 mA	–	0.04	0.20	%
Load Regulation (Notes 3 and 4)	$V_{IN} - V_{OUT}$ = 1.5 V; 10 mA ≤ $I_{OUT} \le$ 5.0 A	–	0.08	0.4	%
Dropout Voltage (Note 5)	I_{OUT} = 5.0 A; $T_J \ge$ 25°C	–	1.15	1.25	V
Current Limit	$V_{IN} - V_{OUT}$ = 3.0 V; $T_J \ge$ 25°C $V_{IN} - V_{OUT}$ = 9.0 V	5.5 –	8.5 1.0	– –	A A
Minimum Load Current	$V_{IN} - V_{OUT}$ = 7.0 V	–	1.2	6.0	mA
Adjust Pin Current		–	50	100	μA
Adjust Pin Current Change	1.5 V ≤ $V_{IN} - V_{OUT} \le$ 4.0 V; 10 mA ≤ $I_{OUT} \le$ 5.0 A	–	0.2	5.0	μA
Thermal Regulation	30 ms pulse; T_A = 25°C	–	0.003	–	%W
Ripple Rejection	f = 120 Hz; C_{Adj} = 25 μF; I_{OUT} = 5.0 A	–	82	–	dB
Temperature Stability	–	–	0.5	–	%
RMS Output Noise	10 Hz ≤ f ≤ 10 kHz; T_A = 25°C	–	0.003	–	%V_{OUT}
Thermal Shutdown	–	150	180	–	°C
Thermal Shutdown Hysteresis	–	–	25	–	°C

3. Load regulation and output voltage are measured at a constant junction temperature by low duty cycle pulse testing. Changes in output voltage due to thermal gradients or temperature changes must be taken into account separately.
4. Specifictions apply for an external Kelvin sense connection at a point on the output pin 1/4" from the bottom of the package.
5. Dropout voltage is a measurement of the minimum input/output differentail at full load.

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PACKAGE PIN DESCRIPTION

Package Pin Number		Pin Symbol	Function
TO−220−3	D^2PAK−3		
1	1	Adj	Adjust pin (low side of the internal reference).
2	2	V_{OUT}	Regulated output voltage (case).
3	3	V_{IN}	Input voltage.

TYPICAL PERFORMANCE CHARACTERISTICS

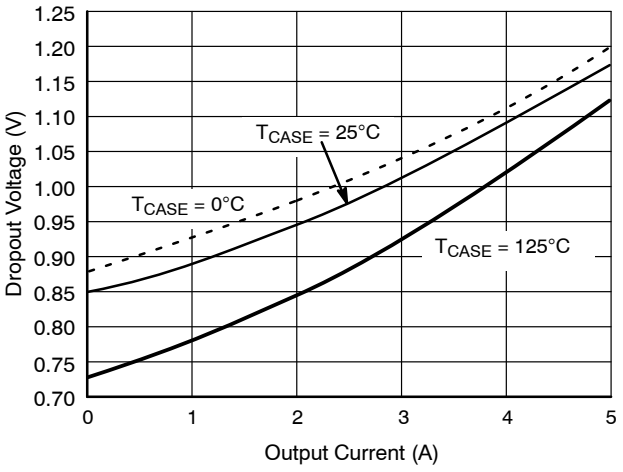


Figure 2. Dropout Voltage vs. Output Current

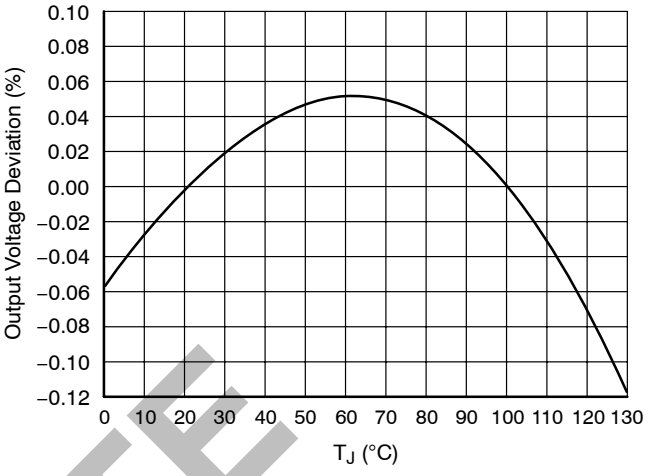


Figure 3. Reference Voltage vs. Temperature

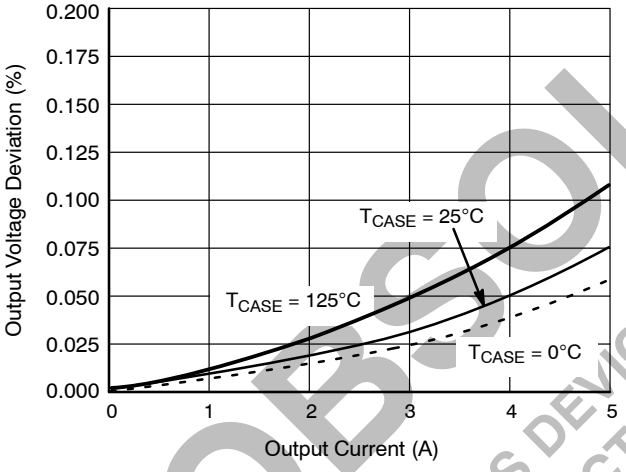


Figure 4. Load Regulation vs. Output Current

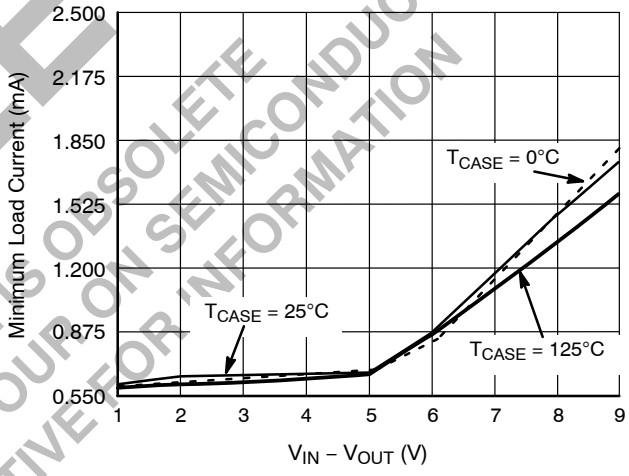


Figure 5. Minimum Load Current

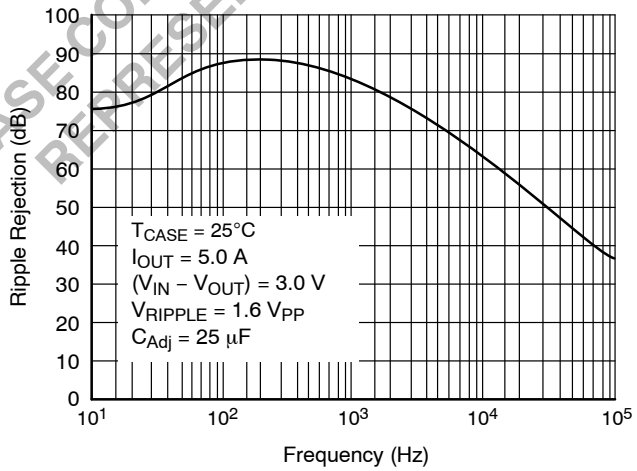


Figure 6. Ripple Rejection vs. Frequency

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APPLICATIONS INFORMATION

The CS5205A−1 linear regulator provides an adjustable voltage at currents up to 5.0 A. The regulator is protected against short circuit, and include thermal shutdown and safe area protection (SOA) circuitry. The SOA protection circuitry decreases the maximum available output current as the input−output differential voltage increases.

The CS5205A−1 has a composite PNP−NPN output transistor and requires an output capacitor for stability. A detailed procedure for selecting this capacitor is included in the Stability Considerations section.

Adjustable Operation

The adjustable regulator (CS5205A−1) has an output voltage range of 1.25 V to 13 V. An external resistor divider sets the output voltage as shown in Figure 7. The regulator maintains a fixed 1.25 V (typical) reference between the output pin and the adjust pin.

A resistor divider network R1 and R2 causes a fixed current to flow to ground. This current creates a voltage across R2 that adds to the 1.25 V across R1 and sets the overall output voltage. The adjust pin current (typically 50 μA) also flows through R2 and adds a small error that should be taken into account if precise adjustment of V_{OUT} is necessary.

The output voltage is set according to the formula:

$$V_{OUT} = V_{REF} \times \left(\frac{R1 + R2}{R1}\right) + I_{Adj} \times R2$$

The term $I_{Adj} \times R2$ represents the error added by the adjust pin current.

R1 is chosen so that the minimum load current is at least 10 mA. R1 and R2 should be the same type, e.g. metal film for best tracking over temperature. The adjust pin is bypassed to improve the transient response and ripple rejection of the regulator.

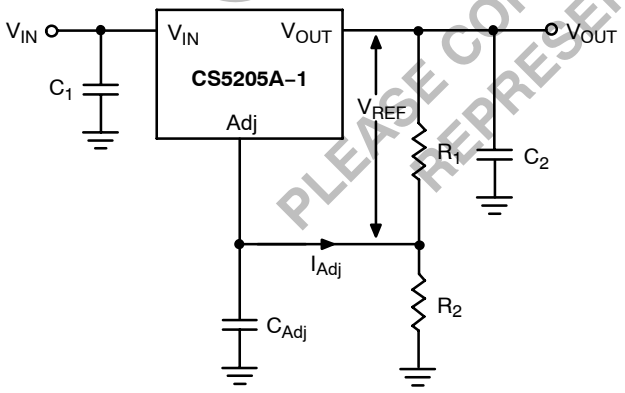


Figure 7. Resistor Divider Scheme for the Adjustable Version

Stability Considerations

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start−up delay, load transient response and loop stability.

The capacitor value and type is based on cost, availability, size and temperature constraints. A tantalum or aluminum electrolytic capacitor is best, since a film or ceramic capacitor with almost zero ESR, can cause instability. The aluminum electrolytic capacitor is the least expensive solution. However, when the circuit operates at low temperatures, both the value and ESR of the capacitor will vary considerably. The capacitor manufacturers data sheet provides this information.

A 22 μF tantalum capacitor will work for most applications, but with high current regulators such as the CS5205A−1 the transient response and stability improve with higher values of capacitor. The majority of applications for this regulator involve large changes in load current so the output capacitor must supply the instantaneous load current. The ESR of the output capacitor causes an immediate drop in output voltage given by:

$$\Delta V = \Delta I \times ESR$$

For microprocessor applications it is customary to use an output capacitor network consisting of several tantalum and ceramic capacitors in parallel. This reduces the overall ESR and reduces the instantaneous output voltage drop under load transient conditions. The output capacitor network should be as close as possible to the load for the best results.

Protection Diodes

When large external capacitors are used with a linear regulator it is sometimes necessary to add protection diodes. If the input voltage of the regulator gets shorted, the output capacitor will discharge into the output of the regulator. The discharge current depends on the value of the capacitor, the output voltage and the rate at which V_{IN} drops. In the CS5205A−1 linear regulator, the discharge path is through a large junction and protection diodes are not usually needed. If the regulator is used with large values of output capacitance and the input voltage is instantaneously shorted to ground, damage can occur. In this case, a diode connected as shown in Figure 8 is recommended.

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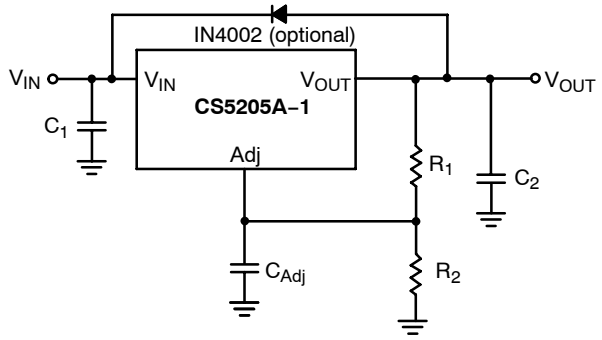


Figure 8. Protection Diode Scheme for Adjustable Output Regulator

Output Voltage Sensing

Since the CS5205A−1 is a three terminal regulator, it is not possible to provide true remote load sensing. Load regulation is limited by the resistance of the conductors connecting the regulator to the load.

Best load regulation occurs when R1 is connected directly to the output pin of the regulator as shown in Figure 9. If R1 is connected to the load, R_C is multiplied by the divider ratio and the effective resistance between the regulator and the load becomes

$$R_C \times \left(\frac{R1 + R2}{R1}\right)$$

where R_C = conductor parasitic resistance.

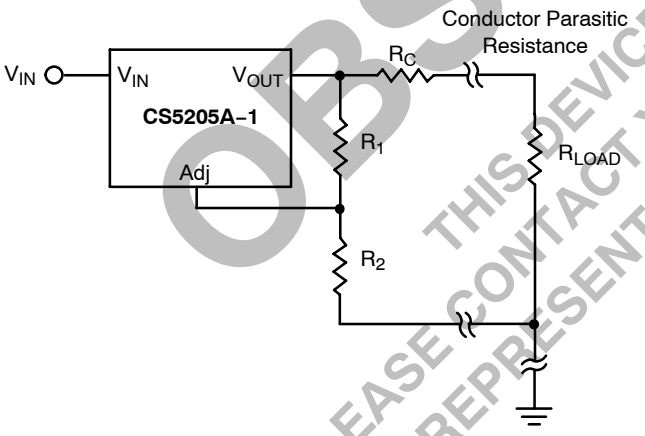


Figure 9. Grounding Scheme for Adjustable Output Regulator to Minimize Parasitics

Calculating Power Dissipation and Heat Sink Requirements

The CS5205A−1 linear regulator includes thermal shutdown and safe operating area circuitry to protect the device. High power regulators such as these usually operate at high junction temperatures so it is important to calculate the power dissipation and junction temperatures accurately to ensure that an adequate heat sink is used.

The case is connected to V_{OUT} on the CS5205A−1, electrical isolation may be required for some applications. Thermal compound should always be used with high current regulators such as these.

The thermal characteristics of an IC depend on the following four factors:

1. Maximum Ambient Temperature T_A (°C)
2. Power dissipation P_D (Watts)
3. Maximum junction temperature T_J (°C)
4. Thermal resistance junction to ambient $R_{\Theta JA}$ (°C/W)

These four are related by the equation

$$T_J = T_A + P_D \times R_{\Theta JA} \quad (1)$$

The maximum ambient temperature and the power dissipation are determined by the design while the maximum junction temperature and the thermal resistance depend on the manufacturer and the package type.

The maximum power dissipation for a regulator is:

$$P_{D(max)} = \{V_{IN(max)} - V_{OUT(min)}\}I_{OUT(max)} + V_{IN(max)}I_Q \quad (2)$$

where:

$V_{IN(max)}$ is the maximum input voltage,

$V_{OUT(min)}$ is the minimum output voltage,

$I_{OUT(max)}$ is the maximum output current, for the application

I_Q is the maximum quiescent current at $I_{OUT(max)}$.

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment has a thermal resistance. Like series electrical resistances, these resistances are summed to determine $R_{\Theta JA}$, the total thermal resistance between the junction and the surrounding air.

1. Thermal Resistance of the junction to case, $R_{\Theta JC}$ (°C/W)
2. Thermal Resistance of the case to Heat Sink, $R_{\Theta CS}$ (°C/W)
3. Thermal Resistance of the Heat Sink to the ambient air, $R_{\Theta SA}$ (°C/W)

These are connected by the equation:

$$R_{\Theta JA} = R_{\Theta JC} + R_{\Theta CS} + R_{\Theta SA} \quad (3)$$

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The value for $R_{\Theta JA}$ is calculated using equation (3) and the result can be substituted in equation (1).

The value for $R_{\Theta JC}$ is normally quoted as a single figure for a given package type based on an average die size. For a high current regulator such as the CS5205A−1 the majority of the heat is generated in the power transistor section. The value for $R_{\Theta SA}$ depends on the heat sink type, while $R_{\Theta CS}$ depends on factors such as package type, heat sink interface (is an insulator and thermal grease used?), and the contact area between the heat sink and the package. Once these calculations are complete, the maximum permissible value of $R_{\Theta JA}$ can be calculated and the proper heat sink selected. For further discussion on heat sink selection, see application note "Thermal Management," document number AND8036/D, available through the Literature Distribution Center or via our website at http://onsemi.com.

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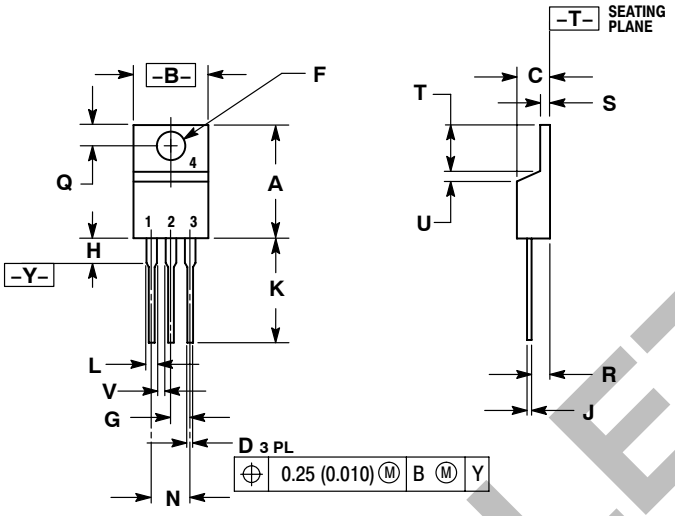
Orderable Part Number	Type	Package	Shipping†
CS5205A−1GT3	5.0 A, Adj. Output	TO−220−3, Straight	50 Units/Rail
CS5205A−1GDP3	5.0 A, Adj. Output	D^2PAK−3	50 Units/Rail
CS5205A−1GDPR3	5.0 A, Adj. Output	D^2PAK−3	750 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PACKAGE DIMENSIONS

TO−220−3
T SUFFIX
CASE 221A−08
ISSUE AA



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.560	0.625	14.23	15.87
B	0.380	0.420	9.66	10.66
C	0.140	0.190	3.56	4.82
D	0.025	0.035	0.64	0.89
F	0.139	0.155	3.53	3.93
G	0.100 BSC		2.54 BSC	
H	---	0.280	---	7.11
J	0.012	0.045	0.31	1.14
K	0.500	0.580	12.70	14.73
L	0.045	0.060	1.15	1.52
N	0.200 BSC		5.08 BSC	
Q	0.100	0.135	2.54	3.42
R	0.080	0.115	2.04	2.92
S	0.020	0.055	0.51	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---

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D²PAK−3
DP SUFFIX
CASE 418AB−01
ISSUE O

For D²PAK Outline and Dimensions – Contact Factory

PACKAGE THERMAL DATA

Parameter		TO−220−3	D²PAK−3	Unit
$R_{\Theta JC}$	Typical	1.6	1.6	°C/W
$R_{\Theta JA}$	Typical	50	10−50*	°C/W

* Depending on thermal properties of substrate. $R_{\Theta JA} = R_{\Theta JC} + R_{\Theta CA}$

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